

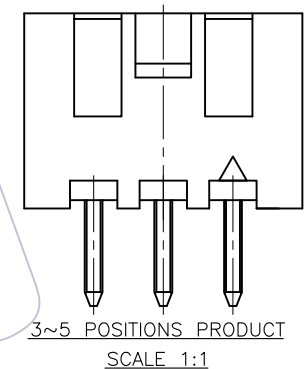
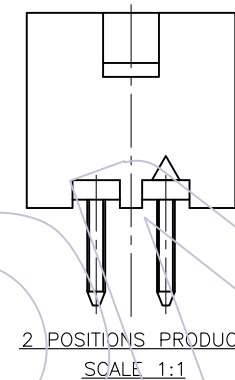
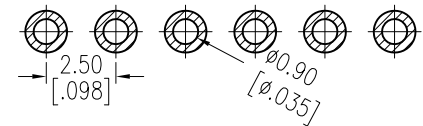
HSF

NOTES:

Current Rating: 3.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 800V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -25°C to +85°C

Contact Material: Brass
Contact plating: Au Or Sn over Ni
Insulator Material: PA66 UL94V-0

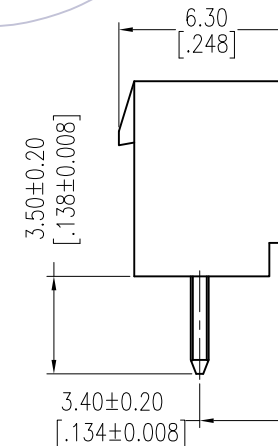
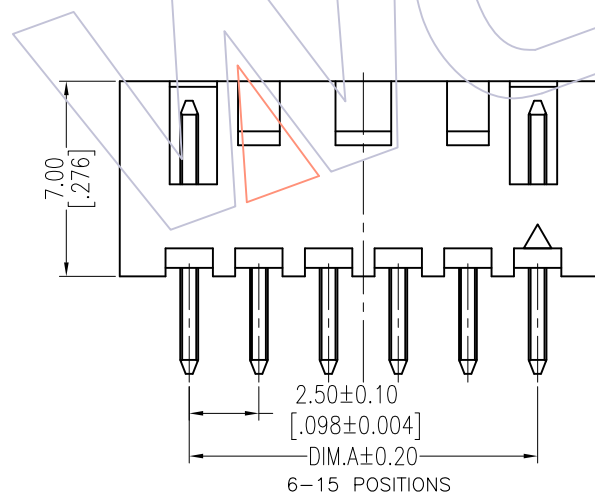
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

WF2501A - WS XX W 0 1

H=PA46 No.of pins Contact Plating
Blank=PA66 02~15P G0=Gold Flash
G3=10u"Gold
G4=15u"Gold
G5=30u"Gold
Blank=Tin
Color
B=Black
W=White
Packing
0=PE Bag
T=Tube



No.Of POSITION	DIM.A	DIM.B	DIM.C
02	2.50	6.10	7.48
03	5.00	8.60	9.98
04	7.50	11.10	12.48
05	10.00	13.60	14.98
06	12.50	16.10	17.48
07	15.00	18.60	19.98
08	17.50	21.10	22.48
09	20.00	23.60	24.98
10	22.50	26.10	27.48
11	25.00	28.60	29.98
12	27.50	31.10	32.48
13	30.00	33.60	34.98
14	32.50	36.10	37.48
15	35.00	38.60	39.98

				OPERATION		DRAW JYHuang	DATE 2013/06/25	SCALE UNIT	FIT mm	PART NO. WF2501A-WSXXW01	TITLE: 2.50 PITCH 180° DIP TYPE SING ROW WAFER
				X.X	±0.40						
				X.XX	±0.25	CHECK	DATE	SIZE A4	SHEET 1/1	Customer NO.	
				X.XXX	±0.15						
				Angle	± 3°	APPROVE	DATE	SHEET 1/1	PROJ.		
				DIM	TOL						
A0	2013/06/25	NEW	-----								
REV	DATE	MODIFICATION DESCRIPTION	CHANGE								